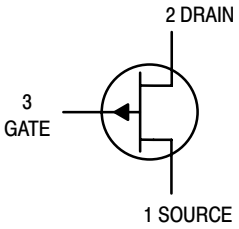
ON Semiconductor™

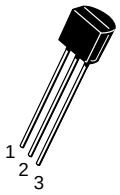
JFET Amplifiers
P–Channel — Depletion



2N5460
2N5461
2N5462

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain–Gate Voltage	V_{DG}	40	Vdc
Reverse Gate–Source Voltage	V_{GSR}	40	Vdc
Forward Gate Current	$I_{G(f)}$	10	mAdc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	350 2.8	mW mW/°C
Junction Temperature Range	T_J	–65 to +135	°C
Storage Channel Temperature Range	T_{stg}	–65 to +150	°C



CASE 29–11, STYLE 7
TO–92 (TO–226AA)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Gate–Source Breakdown Voltage (I_G = 10 μAdc, V_{DS} = 0)	2N5460, 2N5461, 2N5462	$V_{(BR)GSS}$	40	—	—	Vdc
Gate Reverse Current (V_{GS} = 20 Vdc, V_{DS} = 0) (V_{GS} = 30 Vdc, V_{DS} = 0) (V_{GS} = 20 Vdc, V_{DS} = 0, T_A = 100°C) (V_{GS} = 30 Vdc, V_{DS} = 0, T_A = 100°C)	2N5460, 2N5461, 2N5462 2N5460, 2N5461, 2N5462	I_{GSS}	— —	— —	5.0 1.0	nAdc μAdc
Gate–Source Cutoff Voltage (V_{DS} = 15 Vdc, I_D = 1.0 μAdc)	2N5460 2N5461 2N5462	$V_{GS(off)}$	0.75 1.0 1.8	— — —	6.0 7.5 9.0	Vdc
Gate–Source Voltage (V_{DS} = 15 Vdc, I_D = 0.1 mAdc) (V_{DS} = 15 Vdc, I_D = 0.2 mAdc) (V_{DS} = 15 Vdc, I_D = 0.4 mAdc)	 2N5460 2N5461 2N5462	V_{GS}	 0.5 0.8 1.5	 — — —	 4.0 4.5 6.0	Vdc

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS						
Zero–Gate–Voltage Drain Current (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 kHz)	2N5460 2N5461 2N5462	I_{DSS}	–1.0 –2.0 –4.0	— — —	–5.0 –9.0 –16	mAdc
SMALL–SIGNAL CHARACTERISTICS						
Forward Transfer Admittance (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 kHz)	2N5460 2N5461 2N5462	$\lvert y_{fs} \rvert$	1000 1500 2000	— — —	4000 5000 6000	μmhos
Output Admittance (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 kHz)		$\lvert y_{os} \rvert$	—	—	75	μmhos
Input Capacitance (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 MHz)		C_{iss}	—	5.0	7.0	pF
Reverse Transfer Capacitance (V_{DS} = 15 Vdc, V_{GS} = 0, f = 1.0 MHz)		C_{rss}	—	1.0	2.0	pF
FUNCTIONAL CHARACTERISTICS						
Equivalent Short–Circuit Input Noise Voltage (V_{DS} = 15 Vdc, V_{GS} = 0, f = 100 Hz, BW = 1.0 Hz)		e_n	—	60	115	$nV/\sqrt{Hz}$

DRAIN CURRENT versus GATE SOURCE VOLTAGE

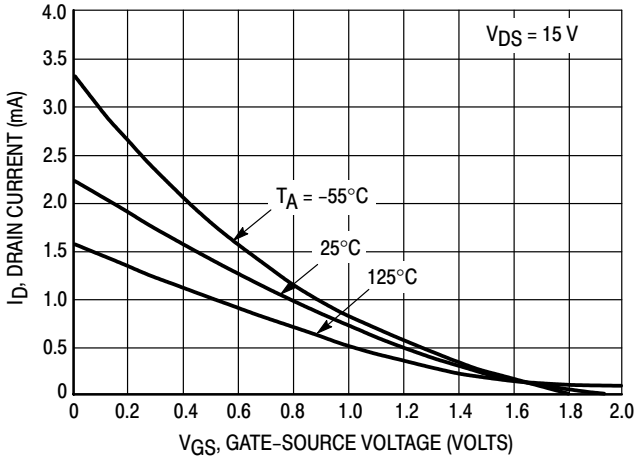


Figure 1. $V_{GS(off)}$ = 2.0 Volts

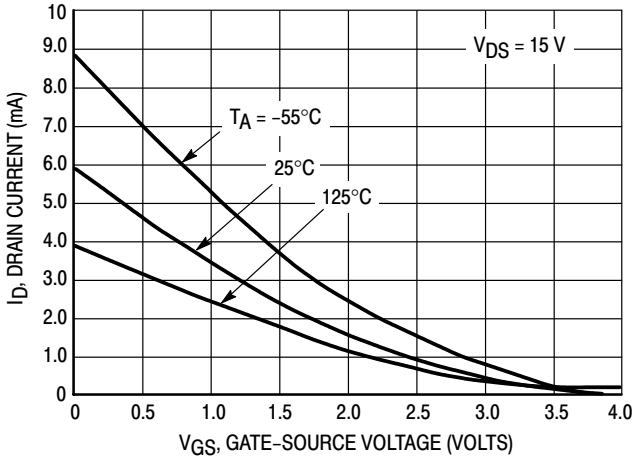


Figure 2. $V_{GS(off)}$ = 4.0 Volts

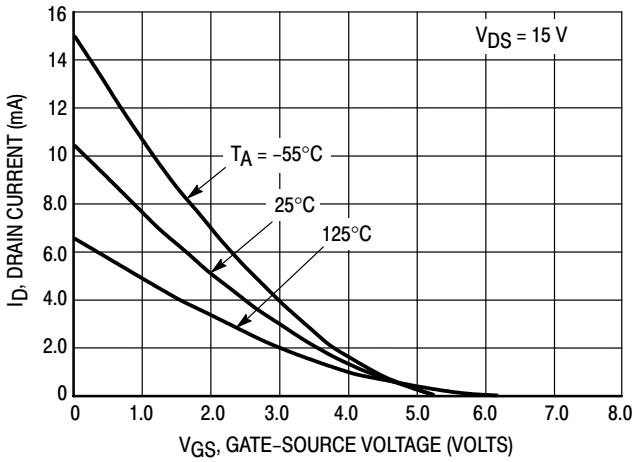


Figure 3. $V_{GS(off)}$ = 5.0 Volts

FORWARD TRANSFER ADMITTANCE versus DRAIN CURRENT

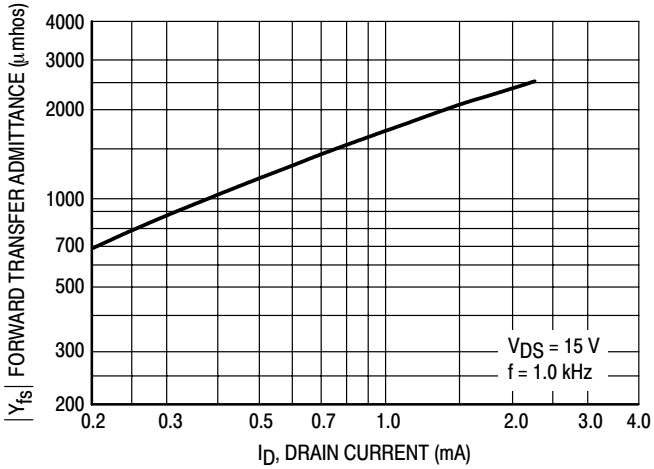


Figure 4. $V_{GS(off)}$ = 2.0 Volts

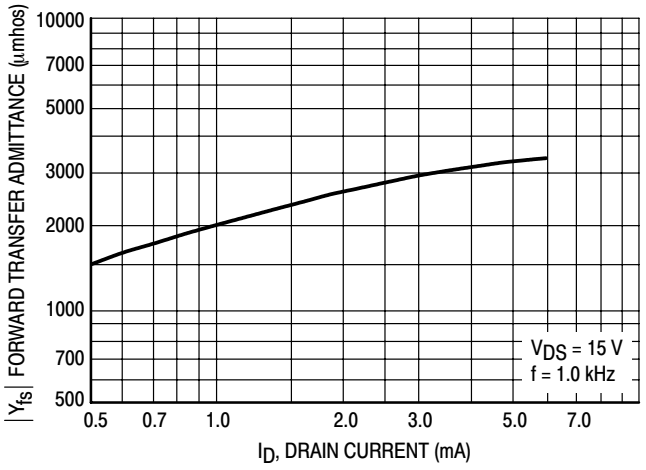


Figure 5. $V_{GS(off)}$ = 4.0 Volts

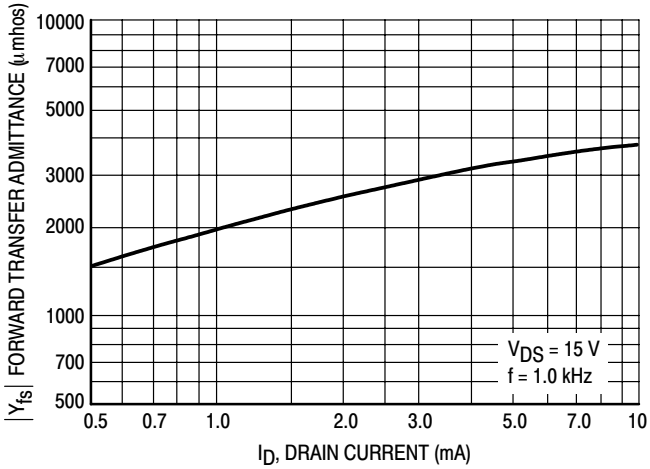


Figure 6. $V_{GS(off)}$ = 5.0 Volts

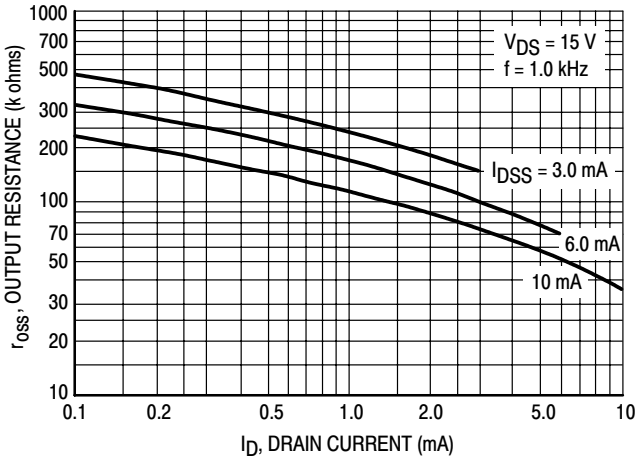


Figure 7. Output Resistance versus Drain Current

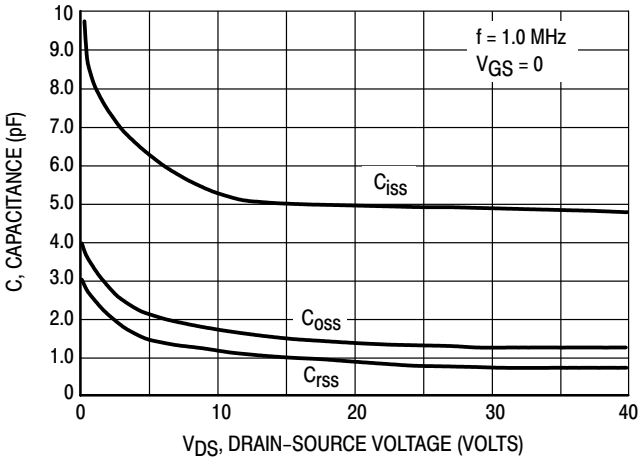


Figure 8. Capacitance versus Drain–Source Voltage

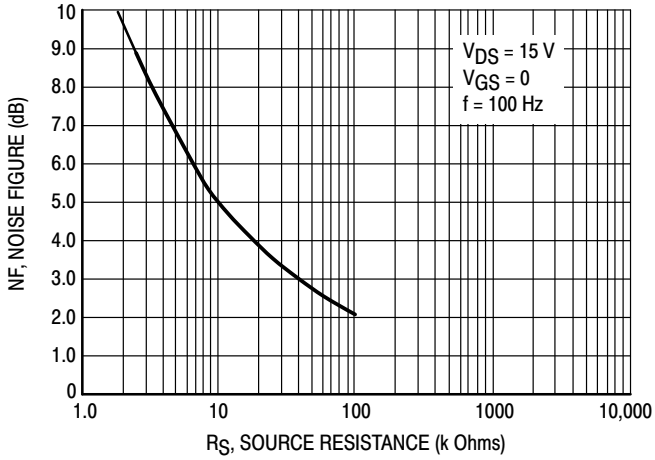
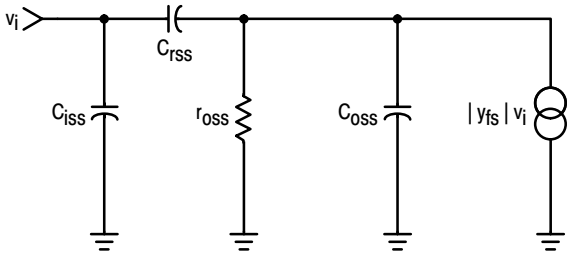


Figure 9. Noise Figure versus Source Resistance



COMMON SOURCE
y PARAMETERS FOR FREQUENCIES
BELOW 30 MHz

$y_{is} = j\omega C_{iss}$
$y_{os} = j\omega C_{osp} * + 1/r_{oss}$
$y_{fs} = y_{fs} |$
$y_{rs} = -j\omega C_{rss}$

*C_{osp} is C_{oss} in parallel with Series Combination of C_{iss} and C_{rss}.

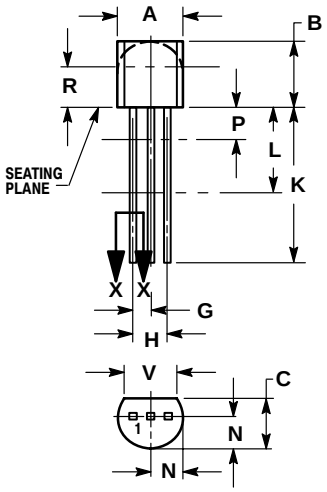
NOTE:

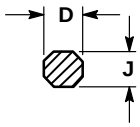
1. Graphical data is presented for dc conditions. Tabular data is given for pulsed conditions (Pulse Width = 630 ms, Duty Cycle = 10%).

Figure 10. Equivalent Low Frequency Circuit

PACKAGE DIMENSIONS

TO–92 (TO–226AA)
CASE 29–11
ISSUE AL





SECTION X–X

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

STYLE 7:
PIN 1. SOURCE
2. DRAIN
3. GATE

Notes

Notes

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